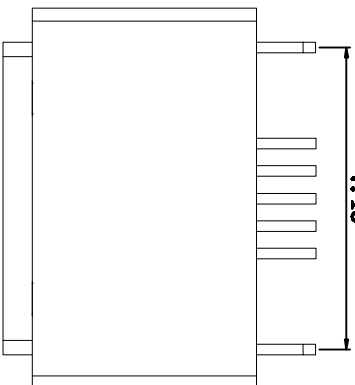


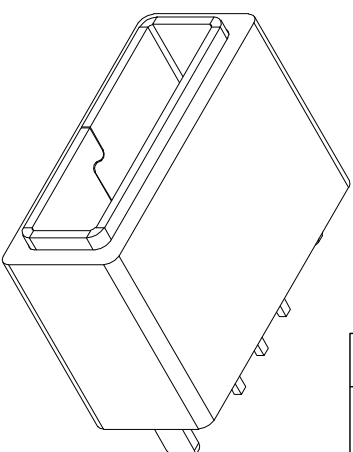
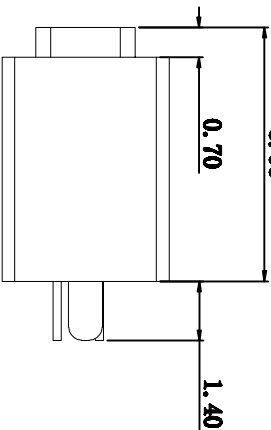


7.15

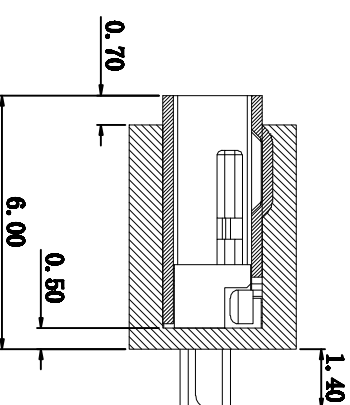
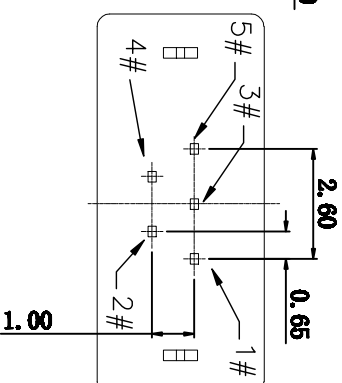
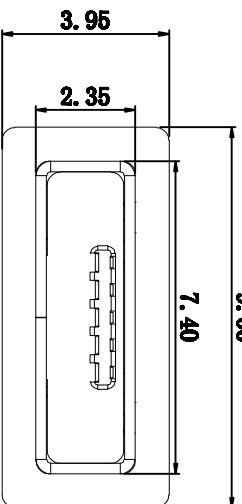
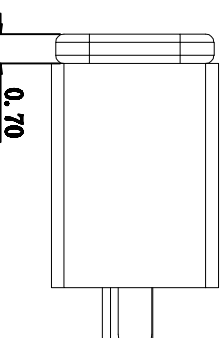


6.00

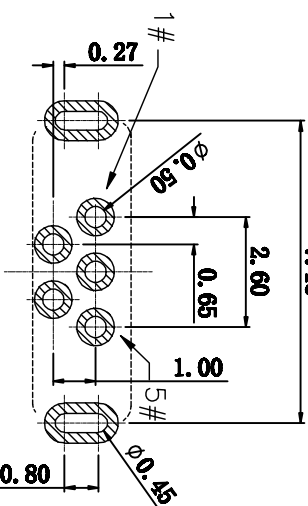
0.70



0.70



7.15



Recommend PCB layout

Note:

1. Material:

1.1 Housing: High temperature thermoplastic with g.f.f, UL94V-0

1.2 Contact: copper alloy, t=0.20mm

1.3 Shell: sus 304, t=0.25mm

2. Specification:

2.1 Current rating: 1.8A Max

2.2 Dielectric withstanding voltage: 100V (AC) for 1 min.

2.3 Contact resistance: 50mΩ Max.

2.4 Insulation resistance: 100mΩ min.

2.5 Total mating force: 3.67 Kgf Max.

2.6 Total unmating force: 1.0 Kgf Min.

2.7 Temperature range: -30° C~80° C

REV	ECN	DESCRIPTION	DATE	ECR
A		发行版	2015/11/16	赵振

Contact Number	Signal Name	Remarks
1#	VBUS	Power
2#	D-	Date-
3#	D+	Date+
4#	ID	Reserve or Gound
5#	GND	Gound
GENERAL TOLERANCE		
X±0.40	x.±	DWG NO
X±0.30	x.±3'	TITLE
.XX±0.20	.xx±2'	PART NO
.XXX±0.10	.xxx±0.1'	SHEET
REV A	SIZE A4	1/1
DRAWING		
CHECKED	赵振	SCALE
APPROVAL		UNIT
DATE	2015/11/16	
深圳市台众益华科技有限公司		